L Number	Hits	Search Text	DB	Time stamp
1	1	second adj strain adj relief adj plate	USPAT;	2004/08/07 14:13
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
2	30501	second adj plate	USPAT;	2004/08/07 14:13
			US-PGPUB;	
		·	ЕРО; ЛРО;	
			DERWENT;	
,	12800	atmin adjustice	IBM_TDB USPAT;	2004/08/07 14:13
3	12800	strain adj relief	US-PGPUB;	2004/06/07 14.13
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
4	100	(second adj plate) and (strain adj relief)	USPAT;	2004/08/07 14:19
_	100	(Second and place) and (Saum and Tener)	US-PGPUB;	200 1/00/07 11:15
			ЕРО; ЛРО;	
			DERWENT,	
			IBM_TDB	
5	319	257/107.ccls.	USPAT;	2004/08/07 14:29
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
6	0	((second adj plate) and (strain adj relief)) and 257/107.ccls.	USPAT;	2004/08/07 14:20
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
7	0	(strain adj relief) and 257/107.ccls.	USPAT;	2004/08/07 14:21
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	0	(googned add mlate) and 257/107 calc	IBM_TDB	2004/08/07 14:21
8	U	(second adj plate) and 257/107.ccls.	USPAT; US-PGPUB;	2004/08/07 14.21
			ЕРО; JPO;	
			DERWENT;	
			IBM_TDB	
9	282137	257/\$.ccls.	USPAT;	2004/08/07 14:21
	,		US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
10	4	((second adj plate) and (strain adj relief)) and 257/\$.ccls.	USPAT;	2004/08/07 14:22
			US-PGPUB;	
			ЕРО; ЈРО;	
			DERWENT;	
			IBM_TDB	
11	36282	pressure adj contact	USPAT;	2004/08/07 14:29
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
12	,	257/107 colo and (mragging adita-t)	IBM_TDB	2004/09/07 14:20
12	1	257/107.ccls. and (pressure adj contact)	USPAT;	2004/08/07 14:30
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM_TDB	
L	<u></u>	<u> </u>	םמו_זאוםד	

12	2102	CTO I Th-mistor	TICDAT.	2004/08/07 14:31
13	3192	GTO and Thyristor	USPAT;	2004/08/07 14:31
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
1.5	,	((CTC) - 1 (The winds - 1 () - 1 () - 1 () - 1 () - 1 () - 1 () - 1 ()	IBM_TDB	2004/00/07 14:21
15	1	((GTO and Thyristor) and (pressure adj contact)) and (second adj plate)	USPAT;	2004/08/07 14:31
			US-PGPUB;	
ļ			ЕРО; ЛРО;	
			DERWENT;	
1.4	72	(OTO 1 Thus'-4-x) 1 (IBM_TDB	2004/09/07 16:01
14	73	(GTO and Thyristor) and (pressure adj contact)	USPAT;	2004/08/07 16:01
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
16	67019	4	IBM_TDB	2004/09/07 16:02
16	67018	dummy	USPAT;	2004/08/07 16:02
			US-PGPUB;	
İ			ЕРО; ЛРО;	
			DERWENT;	
		(COMPORT IN THE STATE OF THE ST	IBM_TDB	2004/00/07 16 22
17	0	((GTO and Thyristor) and (pressure adj contact)) and dummy	USPAT;	2004/08/07 16:32
ĺ			US-PGPUB;	
			ЕРО; ЛРО;	
ļ			DERWENT;	
,,	215610		IBM_TDB	2004/00/07 16 22
18	215610	semiconductor adj substrate	USPAT;	2004/08/07 16:33
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
10	1726206		IBM_TDB	2004/09/07 16:24
19	1736386	substrate	USPAT;	2004/08/07 16:34
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
20	1384597	l comicon duoton	IBM_TDB	2004/09/07 16:24
20	1384397	semiconductor	USPAT; US-PGPUB;	2004/08/07 16:34
			EPO; JPO; DERWENT;	
			IBM_TDB	
21	575234	substrate and semiconductor	USPAT;	2004/08/07 16:58
21	212234	substate and semiconductor	US-PGPUB;	2004/00/07 10:30
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
22	96	GCT and thyristor	USPAT;	2004/08/07 16:59
	/0	OCT MIG MYTISTOL	US-PGPUB;	2007100101 10.33
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
23	0	(GCT and thyristor) and dummy	USPAT;	2004/08/07 16:59
		(001 and arythout) and dummy	US-PGPUB;	2007/00/07 10:37
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
		I		